

Singapore 347722
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## **Information Sheet**

Requested by:	FTSG	Date	ed:	Click h	ere to enter a date.
Business Information:					
Company Name:					
Person to Contact:					
Title:			Salu	itation:	Mr.
Office/Plant Address:					
Country:			ZIP	:	
Email:			TEL	J:	
DID:			Fax	:	
Opportunity Information	1:				
Application:					
Market:					
Quantity: Per Year			-		
System Details/ Technic	cal Requirements:				-
Cold Side Temp. (Tc):	[C <sup>o</sup> ]				000
Hot Side Temp. (Th):	[C <sup>o</sup> ]				
$\Delta$ Temperature ( $\Delta$ T):	$[C^{\circ}]$			OBJECT	BEING COOLED
$\Delta T = Th - Tc$	[C]				electric module
Heat Load (Qc):	[W]		1		leat Sink Th
(Active + Passive)	[ ** ]				
Ambient Temp. (Ta):	[C°]				
Humidity	[%]				<b>V</b>
Heat Sink Thermal				To A	mbient, Ta
Resistance, $(\theta h)$ :	[C/W]			Vin & Iin	
(Ta – Th)/Qh			<u>.</u>	*****	TITIE TO THE
Available (Vin):	[V]				n cooling mode. For heating mode Tc
Power (Iin):	[A]	negative in	dicating	that they ar	te the opposite direction as shown.
Size Requirements:		Cooling mo	ue defii	nea as IC <i< td=""><td>a and Heating mode as Tc&gt;Ta</td></i<>	a and Heating mode as Tc>Ta
Width (W):	[mm]			_	- 11
Length (L):	[mm]			W	
Height (H):	[mm]		н	الموروخ الم	
Application Notes/ Add	itional Design Requiremer	nts: (Sketch)			